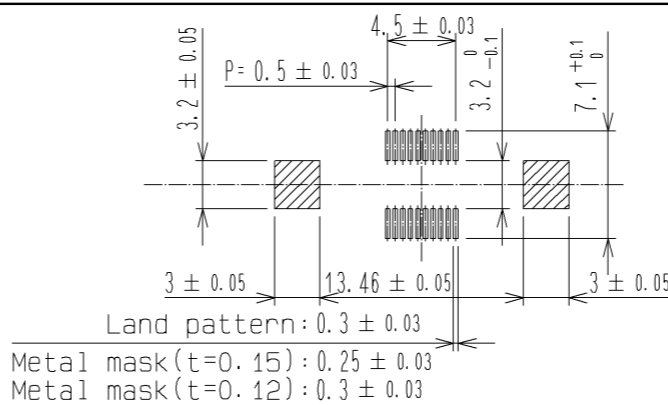
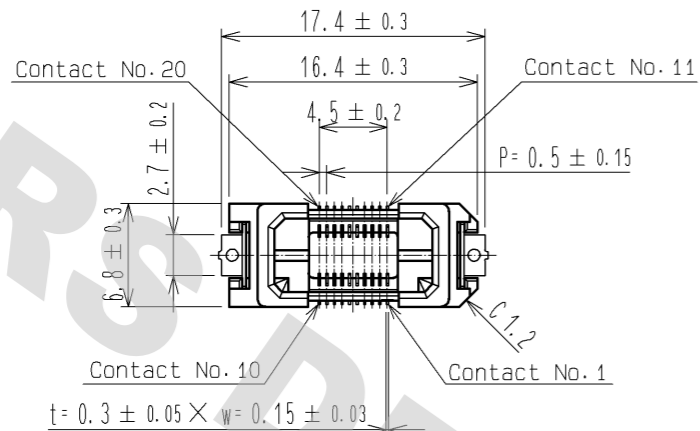
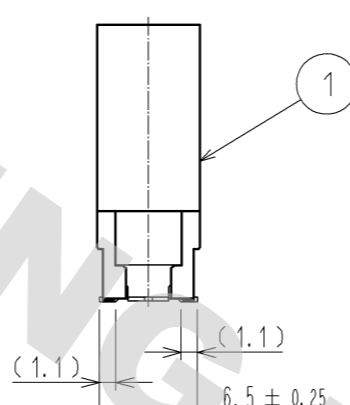
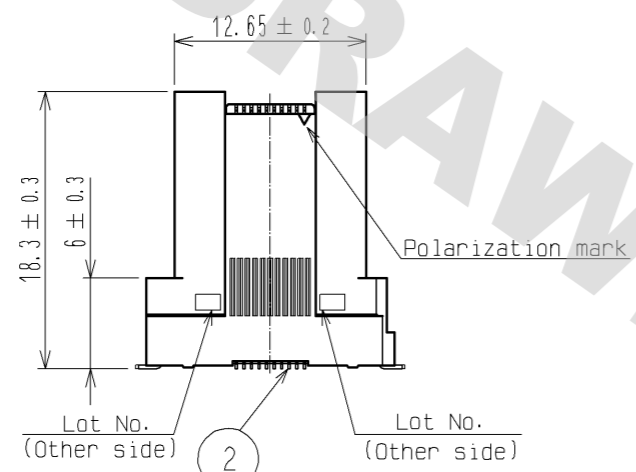
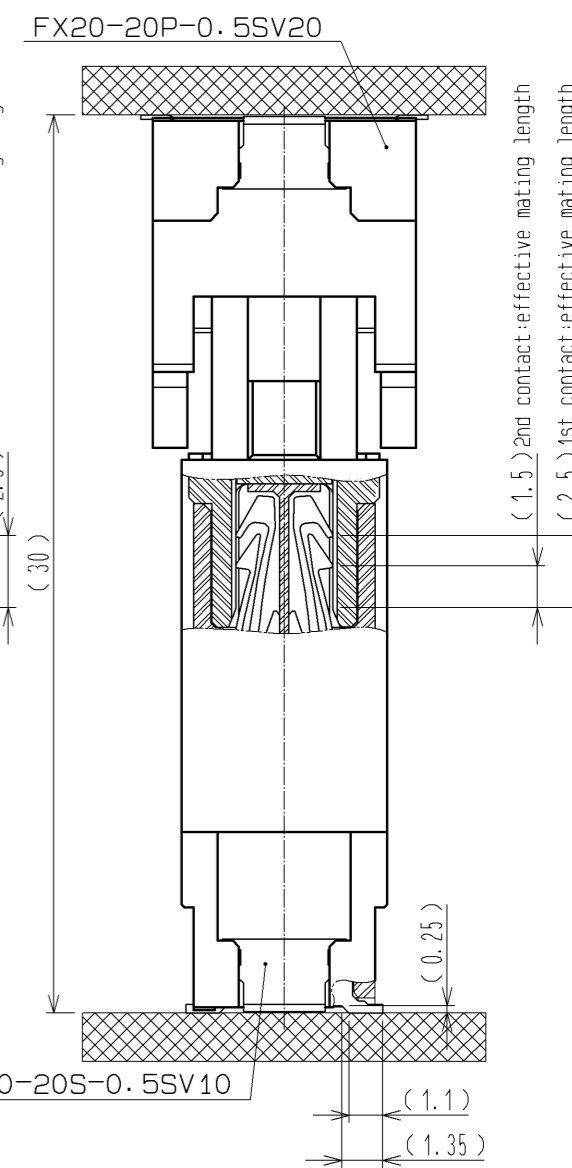


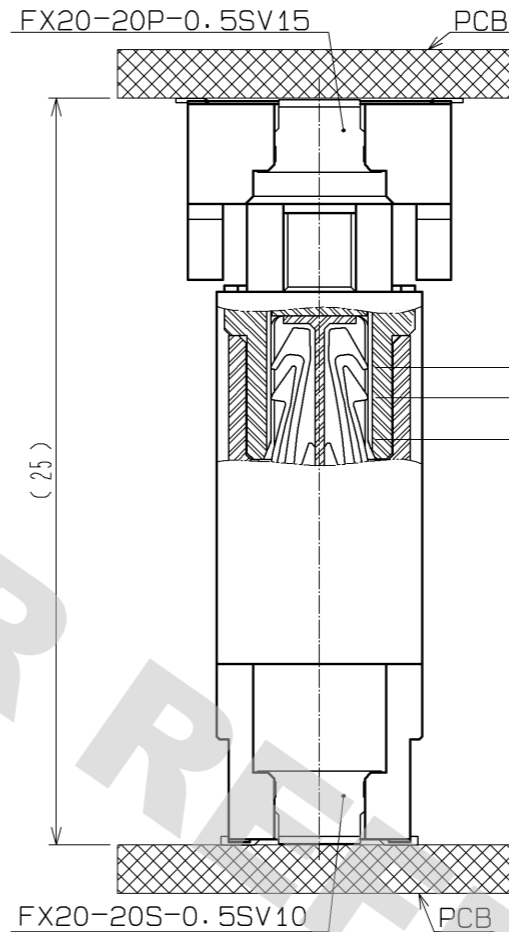
RECOMMENDED LAND PATTERN DIMENSION OF PCB



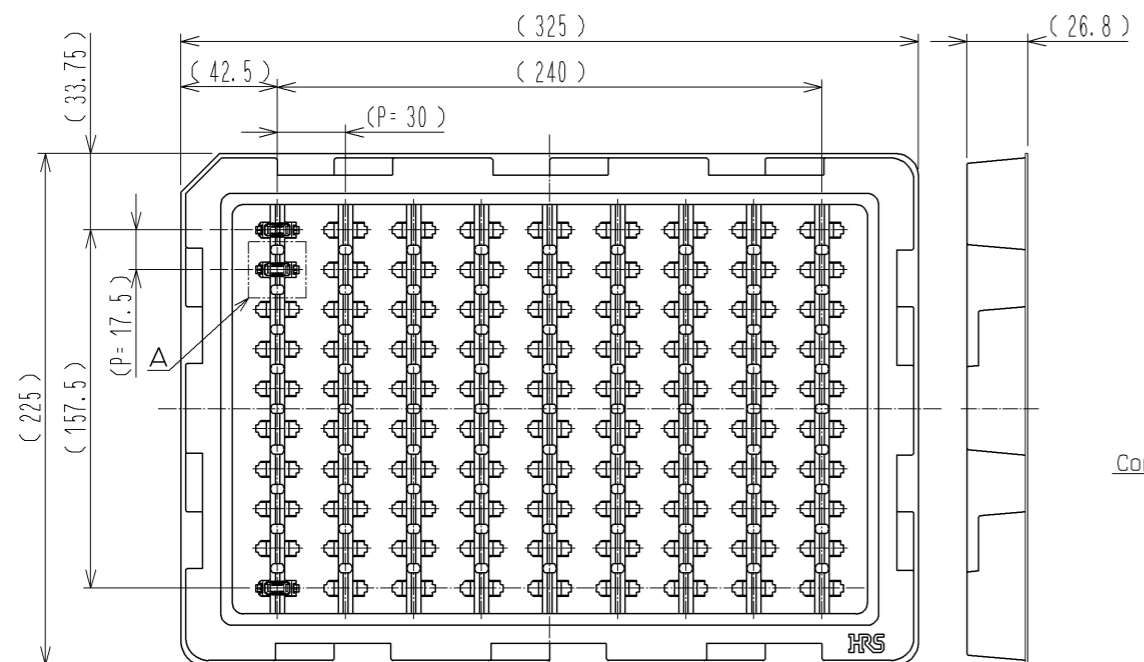
Drawing for mating (No scale)



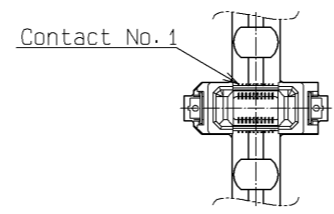
Drawing for mating (No scale)



2 DRAWING FOR PACKING (No scale)



A (1:1)



- 1 Lead CO-Planarity is 0.1mm MAX.
- 2 This is packaged in tray.(90pcs/tray)
- 3 Blemish and hit mark can be occurred through out the manufacturing process which doesn't affect quality level.
- 4 Please note that excessive wrenching force could damage this connector. Please refer to the guideline for detailed regulations of the mating method.
- 5 The dimensions in parentheses are for references.

1	LCP	BLACK	UL94V-0	3	BRASS	TIN-PLATING 1 μm		
				2	PHOSPHOR BRONZE	CONTACT AREA:GOLD 0.1 μm LEAD AREA:GOLD 0.03 μm UNDER PLATING:NICKEL 1 μm		
NO.	MATERIAL	FINISH	REMARKS	NO.	MATERIAL	FINISH	REMARKS	
UNITS	mm	SCALE	2:1	COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
				APPROVED	HS. OKAWA	13.10.07	DRAWING NO. EDC3-349948-00	
				CHECKED	KI. HIROKAWA	13.10.07	PART NO. FX20-20S-0.5SV10	
				DESIGNED	TS. OONO	13.10.07	CODE NO. CL570-1115-0-00	
				DRAWN	TS. OONO	13.10.07	1/1	

DRAWING FOR REFERENCE: This is subject to change without notice 12/05/2013